



## **PRODUCT DATASHEET**



- PLCC2 SMD
- 2835 0.5W Series
- Yellow (590nm)





N0Y15S53

## **APPLICATIONS:**

- Decorative Lighting
- Backlighting
- Indicator
- Display

# 2835 0.5W Series



## **FEATURES:**

- Package: PLCC2 High Power White SMT Package
- Forward Current: 150mA
- Forward Voltage (typ.): 2.4V
- Luminous Flux (typ.): 18lm @150mA
- Colour: Yellow
- Wavelength: 590nm
- Viewing angle: 120°
- Materials:
  - Die: AlGaInP
  - Resin: Silicon (Water Clear)
  - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
  - Forward voltage
  - Luminous flux
  - Dominant wavelength
- Soldering methods: IR Reflow
- **Preconditioning:** acc. to JEDEC Level 3
- Packing: 12mm tape with 2000/reel, ø180mm (7")



## CHARACTERISTICS:

#### Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	150	mA
Peak Forward Current (Duty 1/10; width 10KHz)	I <sub>FP</sub>	300	mA
Reverse Current @5V	I <sub>R</sub>	10	μΑ
Power Dissipation	P <sub>D</sub>	420	mW
Electrostatic Discharge	ESD	2000	V
Junction Temperature	Tj	115	°C
Operating Temperature	T <sub>OPR</sub>	-40~+85	°C
Storage Temperature	T <sub>STG</sub>	-40~+100	°C
Soldering Temperature	T <sub>SD</sub>	260	°C

#### Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	V <sub>F</sub>	1.7	2.4	2.8	V	I <sub>F</sub> =150mA
Luminous Flux	Φν	14	18	22	lm	I <sub>F</sub> =150mA
Dominant Wavelength	$\lambda_{\text{D}}$	585	590	595	nm	I <sub>F</sub> =150mA
Spectral Half Width	Δλ		20		nm	I <sub>F</sub> =150mA
Viewing Angle	20 <sub>1/2</sub>		120		deg	I <sub>F</sub> =150mA

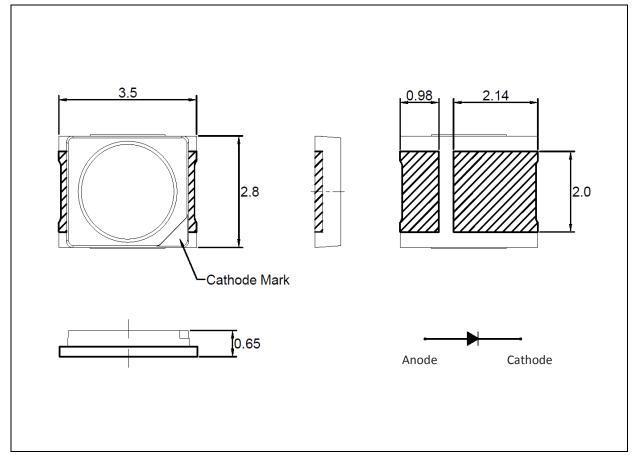
1. Luminous intensity (I\_v) ±15%, Forward Voltage (V\_F) ±0.1V, Viewing angle(2 $\theta_{1/2}$ ) ±5%

2. IS standard testing



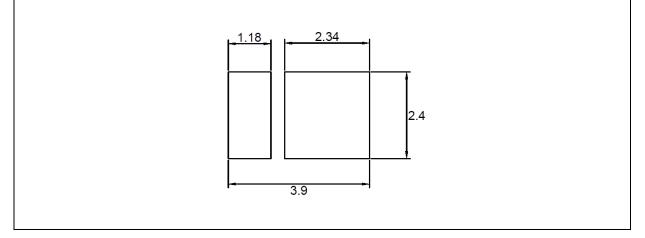
## **OUTLINE DIMENSION:**

#### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



#### **BINNING GROUPS:**

Code	Min.	Max.	Unit
С	1.7	1.8	
D	1.8	1.9	
E	1.9	2.0	
F	2.0	2.1	
G	2.1	2.2	
Н	2.2	2.3	V
I	2.3	2.4	
J	2.4	2.5	
К	2.5	2.6	
L	2.6	2.7	
М	2.7	2.8	

#### Forward Voltage Classifications (I<sub>F</sub> = 150mA):

#### Luminous Flux Classifications ( $I_F = 150 \text{mA}$ ):

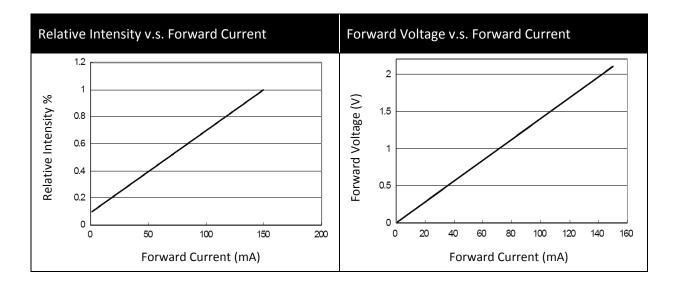
Code	Min.	Max.	Unit
F14D	14	16	
F16D	16	18	Im
F18D	18	20	lm
F20D	20	22	

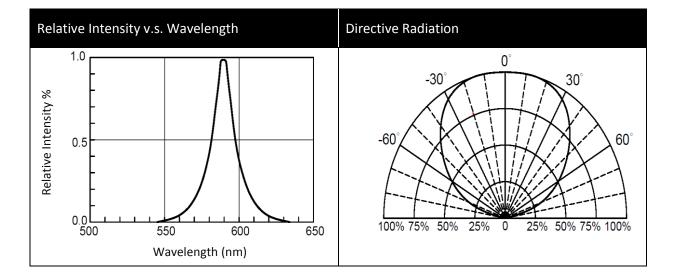
#### Dominant Wavelength Classifications (I<sub>F</sub> = 150mA):

Code	Min. Max.		Unit
15	585	587	
16	587	589	
17-1	589	590	
17-2	590	591	nm
17-3	591	592	
18	592	595	



### **ELECTRO-OPTICAL CHARACTERISTICS:**

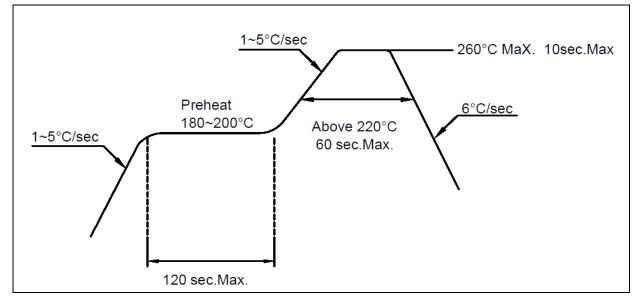






## **RECOMMENDED SOLDERING PROFILE:**

#### IR Reflow Lead-free Solder:



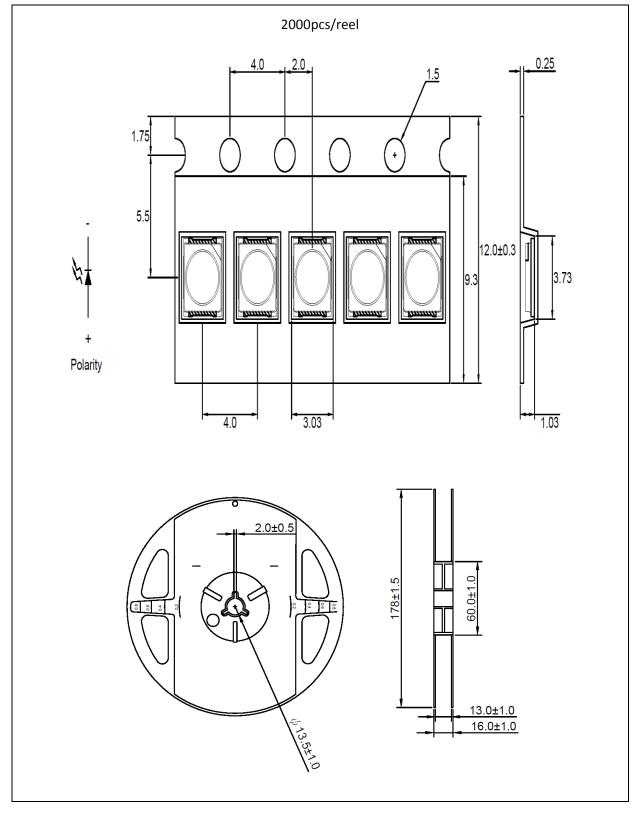
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.



## PACKING SPECIFICATION:

#### Reel Dimension:



#### **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



## **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	26/11/2014	Datasheet set-up.